L Number	Hits	Search Text	DB	Time stamp
-	17	"resist application" with semiconductor with substrate	USPAT; US-PGPUB	2004/06/15 14:18
-	1	("resist application" with semiconductor with substrate) and hmds	USPAT; US-PGPUB	2004/06/15 14:18
-	146	"resist application" with substrate	USPAT; US-PGPUB	2004/06/15 14:46
-	7	("resist application" with substrate) and hmds	USPAT; US-PGPUB	2004/06/15 14:18
-	21944	(resist or photoresist or "photo resist") with (applicat\$4 or	USPAT; US-PGPUB	2004/06/15 14:47
-	924	coat\$3) with (substrate or wafer) ((resist or photoresist or "photo resist") with (applicat\$4 or	USPAT;	2004/06/15 14:47
-	4	coat\$3) with (substrate or wafer)) and hmds (((resist or photoresist or "photo resist") with (applicat\$4 or coat\$3) with (substrate or wafer)) and hmds) and	US-PGPUB USPAT; US-PGPUB	2004/06/15 14:48
-	11	dehumidified ("5571560" "5626913" "5658615" "5695817" "5720814" "5919520" "5962070" "5972426" "6162507" "6234692" "6241403").PN.	USPAT	2004/06/16 08:29
-	3677	((427/240) or (427/314) or (427/444) or (438/782) or (438/780) or (438/905)).CCLS.	USPAT; US-PGPUB	2004/06/16 08:56
-	272	(((427/240) or (427/314) or (427/444) or (438/782) or (438/780) or (438/905)).CCLS.) and (((pre or preliminary) with (treatment or treating or treated)) or "pre-treatment" or	USPAT; US-PGPUB	2004/06/16 09:01
-	8	"pretreatment") (((427/240) or (427/314) or (427/444) or (438/782) or (438/780) or (438/905)).CCLS.) and ("de-humidified" or "dehumidified")	USPAT; US-PGPUB	2004/06/16 09:0
-	115	(((427/240) or (427/314) or (427/444) or (438/782) or (438/780) or (438/905)).CCLS.) and (humidity with (control\$4 or reduc\$4))	USPAT; US-PGPUB	2004/06/16 09:0
-	11	((((427/240) or (427/314) or (427/444) or (438/782) or (438/780) or (438/780), CCLS.) and (((pre or preliminary) with (treatment or treating or treated) or "pre-treatment" or "pretreatment") and ((((427/240) or (427/314) or (427/444) or (438/782) or (438/780) or (438/780). CCLS.) and (humidity with (control34 or reducs4)).	USPAT; US-PGPUB	2004/06/16 09:09
-	3	("5143552" "6306455" "6326597" "2001/0044161" "2002/0025375").PN.	USPAT	2004/06/16 10:20
-	3	("5143552" "6306455" "6326597" "2001/0044161" "2002/0025375").PN.	USPAT	2004/06/21 09:3
-	2	(resist or "photoresist") with (dehumidified or "humidity controll")	USPAT; US-PGPUB	2004/06/21 09:3
- '	4	((resist or "photoresist") with (dehumidified or "humidity control")) and hmds	USPAT; US-PGPUB	2004/06/21 09:4
-	17	(resist or "photoresist") with (dehumidified or "humidity control")	USPAT; US-PGPUB	2004/06/21 09:4
-	2	(resist or "photoresist") with (dehumidified or "humidity	EPO; JPO	2004/06/21 09:4
-	13	(resist or "photoresist") and (dehumidified or "humidity	EPO; JPO	2004/06/21 09:4
-	11		USPAT	2004/06/21 10:0
-	0		USPAT	2004/06/21 10:20